

SID

Factory: Rot am See

Article:

738

ML4

Provided:

Kracht, Enrico

Customer:




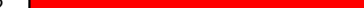

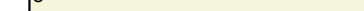
Date:

02.09.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
---------------	----------	----	---------	------------------

Polyimid 50µ -18µ eins CU Kleberlos 460x305...	50201120	<div><div>18</div><div>50</div></div>	VS	<div><div>1</div><div></div></div>	B00
A-RS-FR4-Prepreg-106-LowFlow-R1551LE	50200912	<div><div>50</div></div>		<div><div>2</div><div></div><div>A01</div></div>	
A-RS-FR4-ML-0.61mm-018+018-TG150-HF	50201009	<div><div>18</div></div>	L2	<div><div>3</div><div></div><div>A02</div></div>	
		<div><div>610</div></div>			
		<div><div>18</div></div>	L3		
A-RS-FR4-Prepreg-106-TG150-HF	50200640	<div><div>91</div></div>		<div><div>4</div><div></div></div>	
A-RS-FR4-Prepreg-106-TG150-HF	50200640	<div><div>0</div></div>		<div><div>5</div><div></div></div>	
A-RS Kupferfolie-018my 330x490mm	50200238	<div><div>18</div></div>	RS	<div><div>6</div><div></div></div>	

Thickness after Pressing

B00:

890 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

990 µm

Dmin:

790 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1000 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

1100 µm

Dmin:

900 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

873 µm

Version 1.2.16.21

© Würth Elektronik